PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data			
1.1 Company	life.augmented	STMicroelectronics International N.V	
1.2 PCI No.		ANALOG MEMS SENSORS/25/15818	
1.3 Title of PCI		Additional 2D code in ST Bulk Labels for BEMT & Subcon for APMS MEMS only (CLB and UTAC)	
1.4 Product Category		See impacted product list	
1.5 Issue date		2025-09-09	

2. PCI Team		
2.1 Contact supplier		
2.1.1 Name	KRISZTINA NEMETH	
2.1.2 Phone	+49 89460062210	
2.1.3 Email	krisztina.nemeth@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Simone FERRI	
2.1.2 Marketing Manager	Tarik SOUIBES	
2.1.3 Quality Manager	Fabio BIGANZOLI	

	3. Change	
3.1 Category	Sategory 3.2 Type of change 3.3 Manufacturing Location	
Methods	Standard inner labelling	UTAC Thailand

4. Description of change		
	Old	New
4.1 Description	Standard ST Inner Bulk label doesn't contain 2D code.	Standard ST Inner Bulk label is with additional 2D code.
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	Form : no impact Fit : no impact Function : no impact Reliability : no impact Processability : no impact	

5. Reason / motivation for change	
	Additional 2D code in existing bulk label for (BEMT / SUBCON only) to ensure that during bulk label verification, the bulk labels are unique avoiding the risk of accidentally scanning the same label twice.
5.2 Customer Benefit	QUALITY IMPROVEMENT

	6. Marking of parts / traceability of change	
6.1 Description	Visible on Standard ST Inner Bulk label	

7. Timing / schedule	
7.1 Date of qualification results	2025-08-28
7.2 Intended start of delivery	2025-10-05
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation			
8.1 Description	15818 Additional 2D in Bulk Label_detail_descr_template_file_r2.pdf		
8.2 Qualification report and qualification results		Issue Date	2025-09-09

9. Attachments (additional documentations)

15818 Public product.pdf 15818 Additional 2D in Bulk Label_detail_descr_template_file_r2.pdf

10. Affected parts			
	10. 1 Current	10.2 New (if applicable)	
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No	
	ILPS22QSTR		
	ILPS28QSWTR		
	LPS22DFTR		
	LPS22HBTR		
	LPS22HHTR		
	LPS25HBTR		
	LPS27HHTWTR		
	LPS27HHWTR		
	LPS28DFWTR		
	LSM6DS3TR-C		
	LSM6DSLTR		
	LSM6DSLUSTR		
	LSM6DSMTR		
	LSM6DSOQTR		
	LSM6DSOTR		
	LSM6DSOWTR		
	LSM6DSOXTR		
	LSM6DSV16BXTR		
	LSM6DSV16XTR		
	LSM6DSVTR		
	STTS22HTR		
	STTS22MTR		
	LSM6DSV16BTR		

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